

# **Customer Information Notification**

Issue Date: 26-Mar-2020 Effective Date: 27-Mar-2020

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.



202003035I

Change Category				
[] Wafer Fab Process	[] Assembly Process	[X] Product Marking	[] Test Location	[] Design
[] Wafer Fab Materials	[] Assembly Materials	[ ] Mechanical Specification	[]Test Process	[] Errata
[] Wafer Fab Location	[] Assembly Location	[] Packing/Shipping/Labeling	[] Test   Equipment	[] Electrical spec./Test coverage
[] Firmware	[] Other			ŭ

TEF663xHW, TEA6831HW Family, Marking, Introduction Internal Traceability Code DIDT

### **Description**

From May 2020 onwards, NXP will start with the introduction of an additional code on top of the devices of the TEF663xHW and TEA6831HW family to enhance internal traceability of the NXP assembly line.

This DIDT code will be printed on the unused line 5 under the existing device marking and is an unique device ID for traceability purposes only.

This DIDT code, an unique device ID, enables additional traceability of the device production events (man/machine/method/tooling) from WT, Assembly to FT for internal process improvements. An example of the new marking is shown in the attached document.

### Reason

This change is not expected to affect customers in any way. However, because the change is visible NXP wants to appropriately inform customers of it

### **Identification of Affected Products**

Top side marking

From May 2020 onwards, all listed products of the TEF663xHW and TEA831HW family might have a line 5 marking for internal traceability purposes.

# Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

#### **Disposition of Old Products**

Existing inventory will be shipped until depleted

### Remarks

A packing quantity (box) might contain products with and without DIDT marked.

## **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

#### **About NXP Semiconductors**

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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#### **Affected Part Numbers**

TEF6635HW/V106K

TEF6638HW/V106ZK

TEF6635HW/V106ZK

TEF6638HW/V106K